

68V N-Channel Enhancement Mode MOSFET

Description

The AP80N07NF uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with High EAS. This device is suitable for use as a Battery protection or in other Switching application.

General Features

$V_{DS} = 68V$ $I_D = 80A$

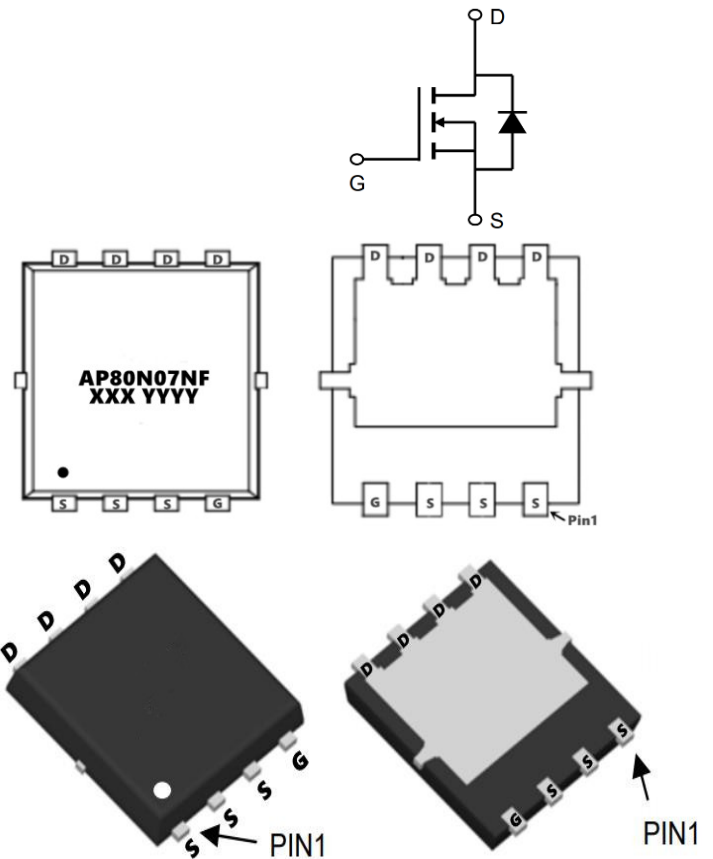
$R_{DS(ON)} < 9.0m\Omega$ @ $V_{GS}=10V$ (Type: **7.2m Ω**)

Application

Battery protection

Load switch

Uninterruptible power supply



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
AP80N07NF	PDFN5X6-8L	AP80N07NF XXX YYYY	5000

Absolute Maximum Ratings ($T_C=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Rating	Units
VDS	Drain-Source Voltage	68	V
VGS	Gate-Source Voltage	± 20	V
$I_D@T_C=25^\circ C$	Continuous Drain Current, $V_{GS} @ 10V^1$	80	A
$I_D@T_C=100^\circ C$	Continuous Drain Current, $V_{GS} @ 10V^1$	52	A
IDM	Pulsed Drain Current ²	320	A
EAS	Single Pulse Avalanche Energy ³	110	mJ
IAS	Avalanche Current	22	A
$P_D@T_C=25^\circ C$	Total Power Dissipation ⁴	103	W
TSTG	Storage Temperature Range	-55 to 150	$^\circ C$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ C$
$R_{\theta JA}$	Thermal Resistance Junction-ambient ¹	63	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance Junction-Case ¹	1.46	$^\circ C/W$

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Electrical Characteristics (T_J=25°C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BVDSS	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	68	72	---	V
ΔBVDSS/ΔT _J	BVDSS Temperature Coefficient	Reference to 25°C, I _D =1mA	---	0.023	---	V/°C
RDS(ON)	Static Drain-Source On-Resistance ²	V _{GS} =10V, I _D =10A	---	7.5	9.0	mΩ
VGS(th)	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	2.0	3.0	4.0	V
ΔVGS(th)	VGS(th) Temperature Coefficient		---	-4.2	---	mV/°C
IDSS	Drain-Source Leakage Current	V _{DS} =68V, V _{GS} =0V, T _J =25°C	---	---	1	uA
		V _{DS} =68V, V _{GS} =0V, T _J =55°C	---	---	5	
IGSS	Gate-Source Leakage Current	V _{GS} =±20V, V _{DS} =0V	---	---	±100	nA
Q _g	Total Gate Charge (4.5V)	V _{DS} =30V, I _D =30A, V _{GS} =10V	---	35	---	nC
Q _{gs}	Gate-Source Charge		---	11	---	
Q _{gd}	Gate-Drain Charge		---	9	---	
Td(on)	Turn-On Delay Time	V _{DS} =30V, I _D =30A, R _{GEN} =3Ω, V _{GS} =10V	---	15	---	ns
T _r	Rise Time		---	90	---	
Td(off)	Turn-Off Delay Time		---	45	---	
T _f	Fall Time		---	30	---	
Ciss	Input Capacitance	V _{DS} =15V, V _{GS} =0V, f=1MHz	---	400	---	pF
Coss	Output Capacitance		---	267	---	
Crss	Reverse Transfer Capacitance		---	250	---	
IS	Continuous Source Current ^{1,5}	V _G =V _D =0V, Force Current	---	---	80	A
ISM	Pulsed Source Current ^{2,5}		---	---	320	A
VSD	Diode Forward Voltage ²	V _{GS} =0V, I _S =80A	---	---	1.2	V
trr	Reverse Recovery Time	T _J =25°C I _F =20A, dI/dt=100A/μs	---	78	---	nS
Q _{rr}	Reverse Recovery Charge		---	51	---	nC

Note :

- 1、The data tested by surface mounted on a 1 inch²FR-4 board with 2OZ copper.
- 2、The data tested by pulsed, pulse width .The EAS data shows Max. rating .
- 3、The test cond ≅ 300us duty cycle ≅ 2%, duty cycle ition is T_J=25°C, V_{DD} =35V, V_G =10V, R_G =25Ω, L=0.5mH, I_{AS} =21A
- 4、The power dissipation is limited by 175°C junction temperature
- 5、The data is theoretically the same as I_D and I_{DM}, in real applications, should be limited by total power dissipation.

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Typical Characteristics

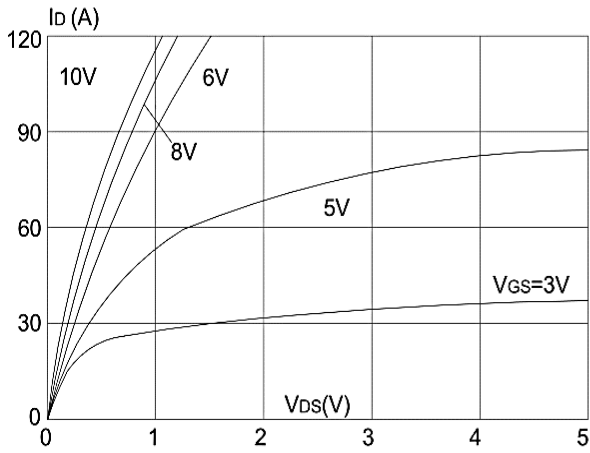


Figure 1: Output Characteristics

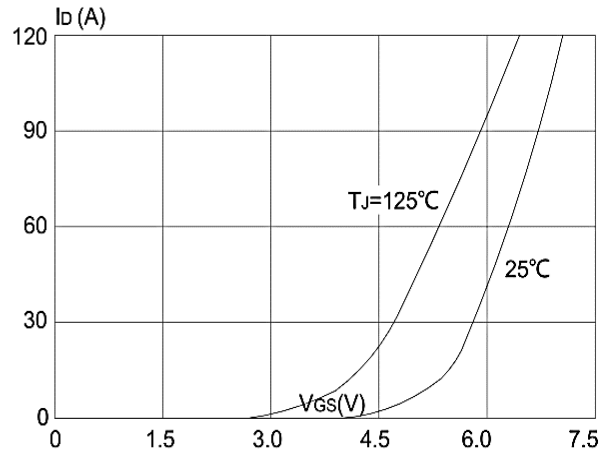


Figure 2: Typical Transfer Characteristics

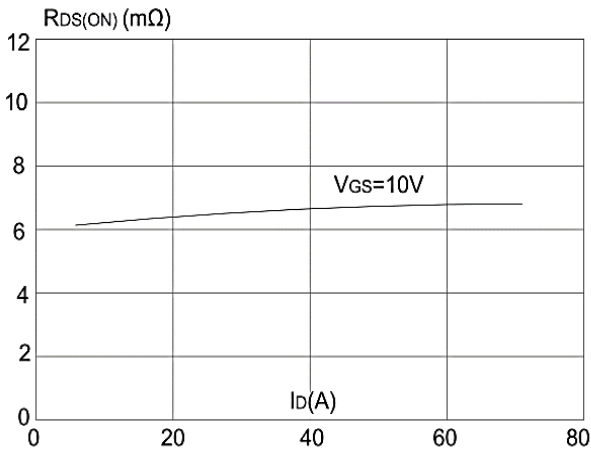


Figure 3: On-resistance vs. Drain Current

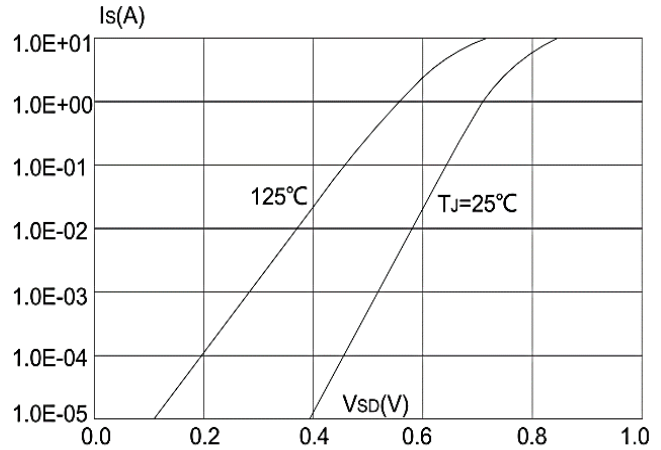


Figure 4: Body Diode Characteristics

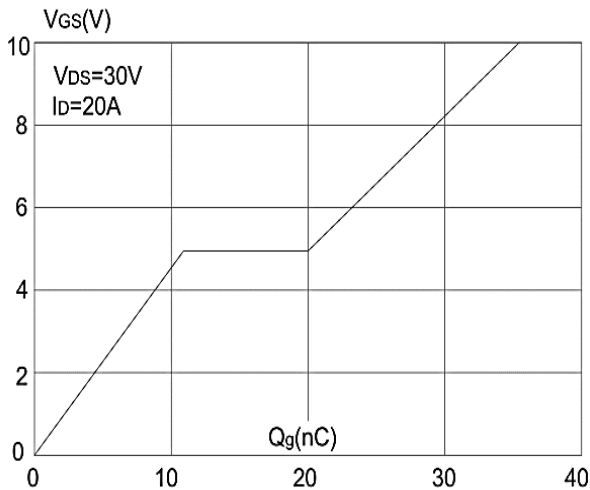


Figure 5: Gate Charge Characteristics

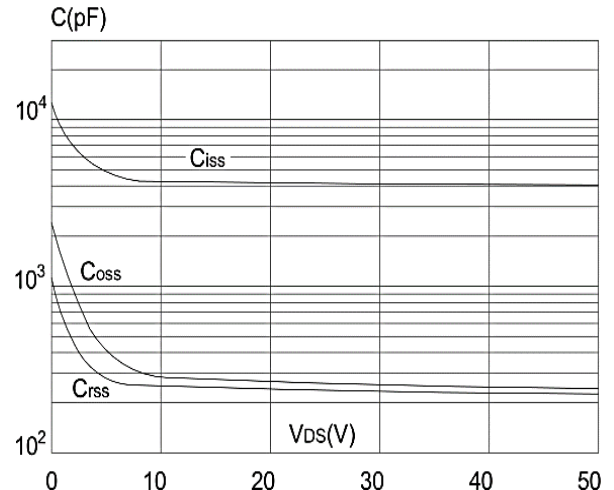


Figure 6: Capacitance Characteristics

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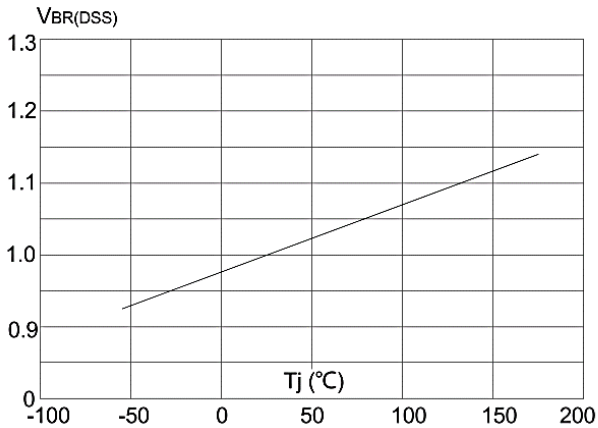


Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

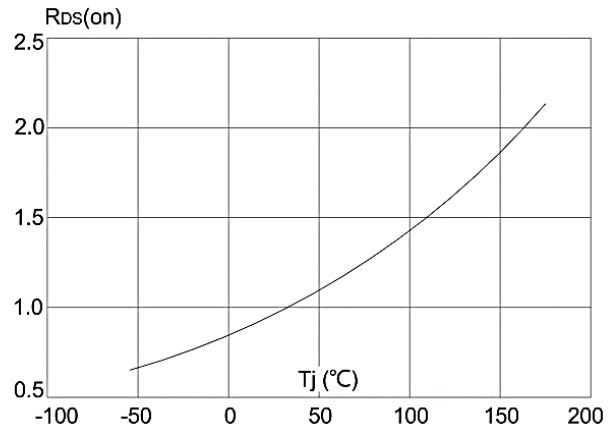


Figure 8: Normalized on Resistance vs. Junction Temperature

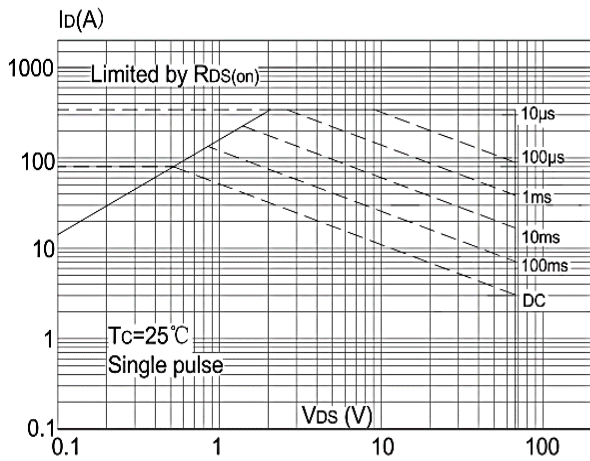


Figure 9: Maximum Safe Operating Area

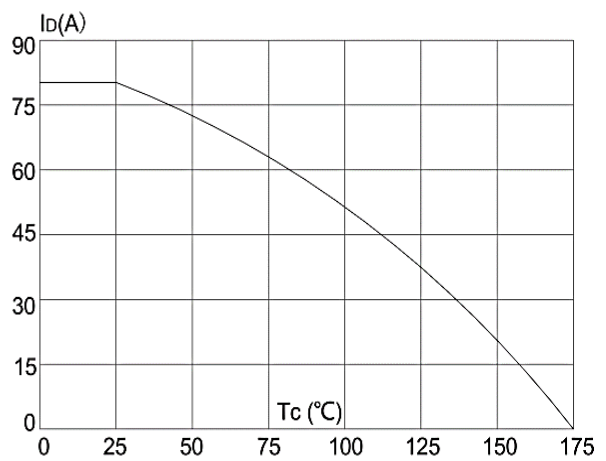


Figure 10: Maximum Continuous Drain Current vs. Ambient Temperature

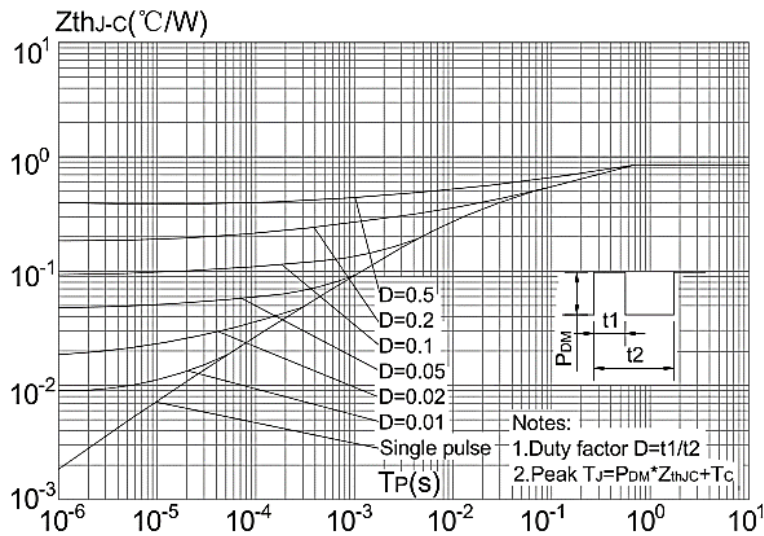
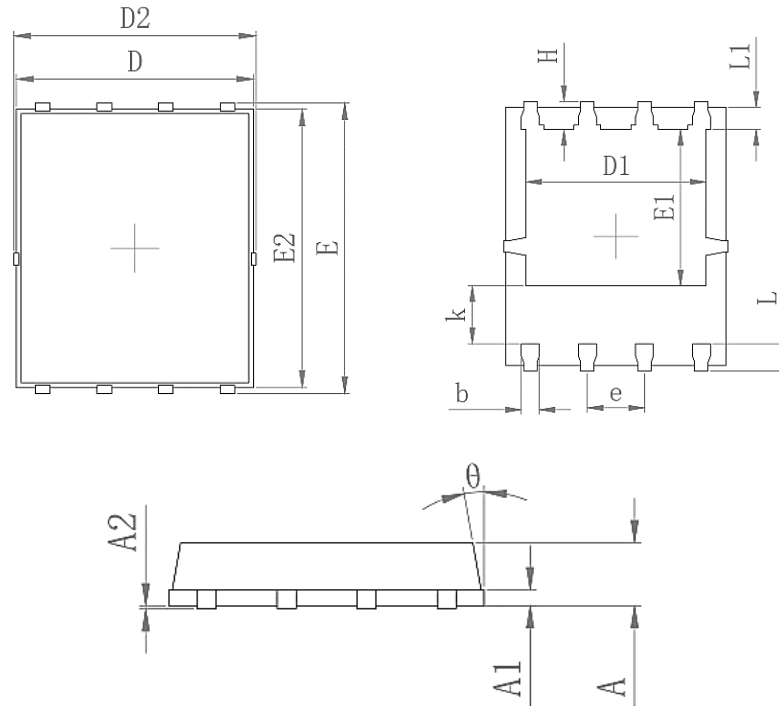


Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Ambien

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Package Mechanical Data-PDFN5X6-8L-XZT Single


Symbol	Common	
	mm	
	Mim	Max
A	0.90	1.10
A1	0.254 REF	
A2	0-0.05	
D	4.824	4.976
D1	3.910	4.110
D2	4.944	5.076
E	5.924	6.076
E1	3.375	3.575
E2	5.674	5.826
b	0.350	0.450
e	1.270	
L	0.534	0.686
L1	0.424	0.576
K	1.190	1.390
H	0.549	0.701
Φ	8°	12°